MLO™ Tight Tolerance Inductors / RF





The Multilayer Organic Tight Tolerance Inductor is a low profile organic based inductor that can support mobile communications, satellite applications, GPS, matching networks, and collision avoidance. The MLO™ Tight Tolerance Inductor series of components are based on AVX's patented multilayer organic technology (US patent 6,987,307). MLO™ Tight Tolerance Inductors incorporate very low loss organic materials which allow for high Q and high stability over frequency. MLO™ Tight Tolerance Inductors are surface mountable and are expansion matched to FR4 printed wiring boards. MLO™ Tight Tolerance Inductors utilize fine line high density interconnect technology thereby allowing for tight tolerance control and high repeatability. Reliability testing is performed to JEDEC and mil standards. Finishes are available in RoHS compliant Sn.

APPLICATIONS

- Mobile communications
- Satellite Applications
- Collision Avoidance
- Wireless LAN's

FEATURES

- Tight Tolerance
- High Frequency
- High Withstanding Voltage
- Low DC Resistance
- Surface Mountable
- 0402 Case Size
- RoHS Compliant Finishes
- Available in Tape and Reel

SURFACE MOUNT **ADVANTAGES**

- Inherent Low Profile
- Excellent Solderability
- Low Parasitics
- Better Heat Dissipation
- Expansion Matched to PCB

HOW TO ORDER





Inductance Expressed in nH (2 significant digits + number of zeros) for values <10nH,

letter R denotes decimal point. Example: 22nH = 2204.7nH = 4R7



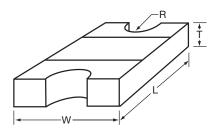
 $B = \pm 0.1 nH$

 $G = \pm 2\%$

T **Termination** Sn100



DIMENSIONS



mm (inches)

L	W	Т	R
1.00±0.10	0.58±0.075	0.35±0.10	0.125±0.050
(0.040±0.004)	(0.023±0.003)	(0.014±0.004)	(0.005±0.002)

QUALITY INSPECTION

Finished parts are 100% tested for electrical parameters and visual characteristics.

TERMINATION

RoHS compliant Sn finish.

OPERATING TEMPERATURE

-55°C to +125°C



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0402 ELECTRICAL SPECIFICATIONS

L (nH) 450MHz	Available Inductance Tolerance A = ±0.05nH, B = ±0.1nH G = ±2%	Q 450MHz	Idc max (mA)	Rdc max (mΩ)	SRF min (GHz)
0.8	±0.05nH, ±0.1nH	15	450	100	7
0.9	±0.05nH, ±0.1nH	15	450	100	7
1	±0.05nH, ±0.1nH	15	420	100	7
1.1	±0.05nH, ±0.1nH	15	410	100	7
1.2	±0.05nH, ±0.1nH	15	410	110	7
1.3	±0.05nH, ±0.1nH	15	295	13	7
1.5	±0.05nH, ±0.1nH	15	295	150	7
1.6	±0.05nH, ±0.1nH	15	230	150	7
1.8	±0.05nH, ±0.1nH	15	295	160	7
2	±0.05nH, ±0.1nH	15	230	18	7
2.2	±0.05nH, ±0.1nH	15	230	200	7
2.4	±0.05nH, ±0.1nH	15	230	200	7
2.7	±0.05nH, ±0.1nH	15	230	250	7
3	±0.05nH, ±0.1nH	15	200	300	7
3.3	±0.05nH, ±0.1nH	15	200	340	7
3.6	±0.05nH, ±0.1nH	15	180	350	7
3.9	±0.05nH, ±0.1nH	15	180	400	7
4.7	±0.1nH	15	170	480	7
5.6	±0.1nH	15	150	500	7
6.8	±0.1nH	15	140	600	7
8.2	±0.1nH	15	115	800	6
10	±2%	15	105	1000	5
12	±2%	15	95	1100	4
15	±2%	15	95	1200	4
18	±2%	15	85	1500	3
22	±2%	15	75	1900	3
27	±2%	15	75	2100	3
30	±2%	15	65	2200	2
32	±2%	15	65	2200	2

Specifications based on performance of component assembled properly on printed circuit board with 500 nominal impedance.